## 506572752 03/24/2021

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NEW ASSIGNMENT	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT		
CONVEYING PARTY	DATA				
		Name	Exect	Execution Date	
ERIC BOHANNON			03/09/2	2021	
RECEIVING PARTY	ΟΑΤΑ				
Name:	SONY	SONY SEMICONDUCTOR SOLUTIONS CORPORATION			
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State/Country:	JAPAN	JAPAN			
Postal Code:	243-00	243-0014			
	PS Totals 1				
PROPERTY NUMBERS Total: 1 Property Type		Number			
		17149045			
CORRESPONDENCE	DATA				
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		the e-mail address first; if that ; if that is unsuccessful, it will		be sent	
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ATTORNEY DOCKET NUMBER:		880005-6667-US01	880005-6667-US01		
NAME OF SUBMITTER:		CHRISTOPHER M. TOBIN	CHRISTOPHER M. TOBIN		
SIGNATURE:		/Christopher M. Tobin/	/Christopher M. Tobin/		
DATE SIGNED:		03/24/2021	03/24/2021		
Fotal Attachments: 2					
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		ited Assignment Bohannon#pag			

## ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, the person(s) named below (referred to as "INVENTOR" whether singular or plural) has sold, assigned, and transferred and does hereby sell, assign, and transfer to **Sony Semiconductor Solutions Corporation** located and doing business at **4-14-1 Asahicho**, **Atsugi-shi**, **Kanagawa**, **243-0014 Japan** ("ASSIGNEE") for itself and its successors, transferees, and assignees, the following:

1. The entire worldwide right, title, and interest in all inventions and improvements ("SUBJECT MATTER") that are disclosed in the U.S. provisional application, non-provisional application, or national phase application entitled **"CTIA PIXEL WITH SHARED RESET NETWORK"**, bearing the U.S. Application Serial No. 17,149,045, filed on January 14, 2021 ("APPLICATION"); and

2. The entire worldwide right, title, and interest in and to: (a) the APPLICATION; (b) all applications claiming priority from the APPLICATION; (c) all utility, divisional, continuation, substitute, renewal, reissue, and other related applications thereto which have been or may be filed in the United States or elsewhere in the world; (d) all patents (including reissues and re- examinations) which may be granted on the applications set forth in (a), (b), (c) and

(d) above; and (e) all right of priority in the APPLICATION, together with all rights to recover damages for infringement of provisional rights.

INVENTOR agrees that ASSIGNEE may apply for and receive patents for SUBJECT MATTER in ASSIGNEE's own name.

INVENTOR agrees to do the following, when requested, and without further consideration, in order to carry out the intent of this Assignment: (I) execute all oaths, assignments, powers of attorney, applications, and other papers necessary or desirable to fully secure to ASSIGNEE the rights, titles and interests herein conveyed; (2) communicate to ASSIGNEE all known facts relating to the SUBJECT MATTER; and (3) generally do all lawful acts that ASSIGNEE shall consider desirable for securing, maintaining, and enforcing worldwide patent protection relating to the SUBJECT MATTER and for vesting in ASSIGNEE the rights, titles, and interests herein conveyed. INVENTOR further agrees to provide any successor, assign, or legal representative of ASSIGNEE with the benefits and assistance provided to ASSIGNEE hereunder.

INVENTOR represents that INVENTOR has the rights, titles, and interests to convey as set forth herein, and covenants with ASSIGNEE that the INVENTOR has not made and will not hereafter make any assignment, grant, mortgage, license, or other agreement affecting the rights, titles, and interests herein conveyed. INVENTOR grants the attorney(s) of record in this application the power to inspect the U.S. Application Serial No. and filing date of the Application in the spaces provided above.

This Assignment may be executed in one or more counterparts, each of which shall be deemed an original and all of which may be taken together as one and the same Assignment.

This Assignment is executed on the date(s) indicated below.

Eric Bohannon Name of first inventor

San Diego, California, USA Residence of first inventor

/ Eric Bohannon / Signature of first inventor

 $_{\text{Date}} \underline{\text{Mar 9, 2021}}$